

MULTI-INNO TECHNOLOGY CO., LTD.

LCD MODULE SPECIFICATION

Model: MI12864AL-G

Revision	1.0
Engineering	
Date	
Our Reference	



MODE OF DISPLAY

Display mode	Display condition	Viewing direction
STN: Yellow green	☐ Reflective type	6 O' clock
☐ Grey	☐ Transflective type	☐ 12 O' clock
☐ Blue (negative)	☐ Transmissive type	3 O' clock
☐ FSTN positive	Others	9 O' clock
☐ FSTN negative		



GENERAL DESCRIPTION

128 X 64 dots, graphic COG LCD module Display mode

Interface Parallel/serial

Driving method 1/65 duty, 1/9 bias

Controller IC Sitronix ST7565P or equivalent

For the detailed information, please refer to the IC specifications.

MECHANICAL DIMENSIONS

Item	Dimension	Unit	Item	Dimension	Unit
Outline Dimension			Dot Pitch	0.52(L)x0.52(W)	mm
	77.0(L) x50.6 (W) x2.9 (H)(MAX)	mm	Dot Size	0.49(L)x0.49(W)	mm
LED side-lited backlight	78.4(L) x53.0 (W) x 7.0(H)	mm	Viewing Area	70.6(L)x38.6(W)	mm

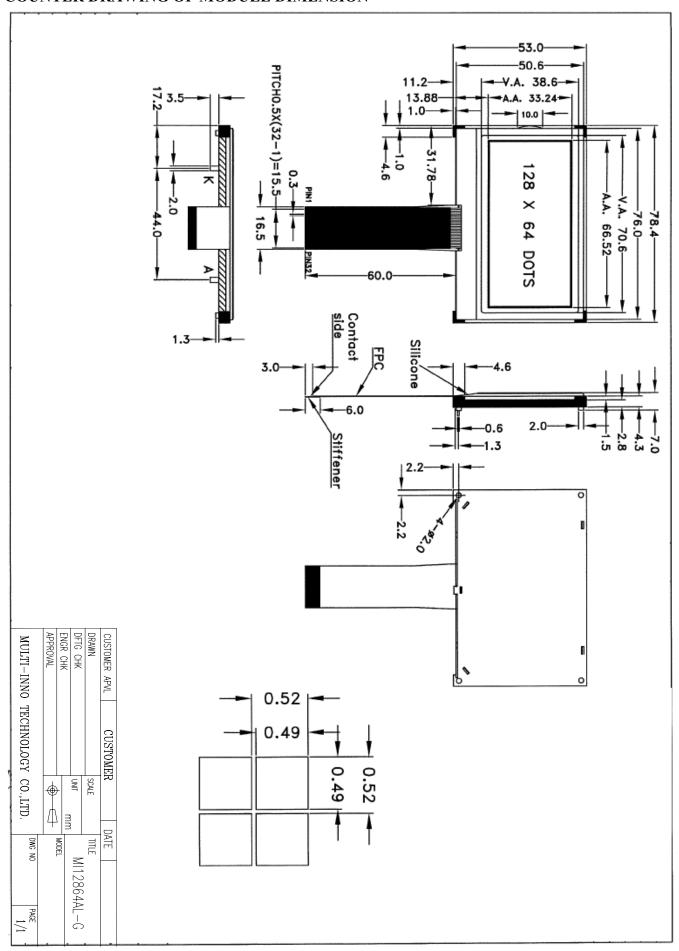
CONNECTOR PIN ASSIGNMENT

		III HODIGI WILLIA			
Pin No.	Symbol	Function	Pin No.	Symbol	Function
1	NC	No connection	18	D7 (SDA)	Data bus (serial data input)
2	NC	No connection	19	D6 (SCL)	Data bus (serial clock input)
3	P/S	Parallel / serial data input select	20	D5	
4	C86	Mode select	21	D4	
5	V0		22	D3	
6	V1		23	D2	Data bus
7	V2	Power supply for LCD	24	D1	
8	V3		25	D0	
9	V4		26	RD (EN)	Read signal(enable input signal for 6800 mode
10	CAP2N		27	WR(R/W)	Write signal(read/write signal for 6800mode)
11	CAP2P		28	A0	Control instruction
12	CAP1P		29	RES	Reset
13	CAP1N	Voltage converter	30	CS1	Chip select
14	CAP3P		31	NC	No connection
15	VOUT		32	NC	No connection
16	VSS	Ground	*33	A	Supply voltage for backlight(+VE)
17	VDD	Supply voltage for logic	*34	K	Supply voltage for backlight(-VE)

Note (*): Pin 33, 34 are used for backlight version

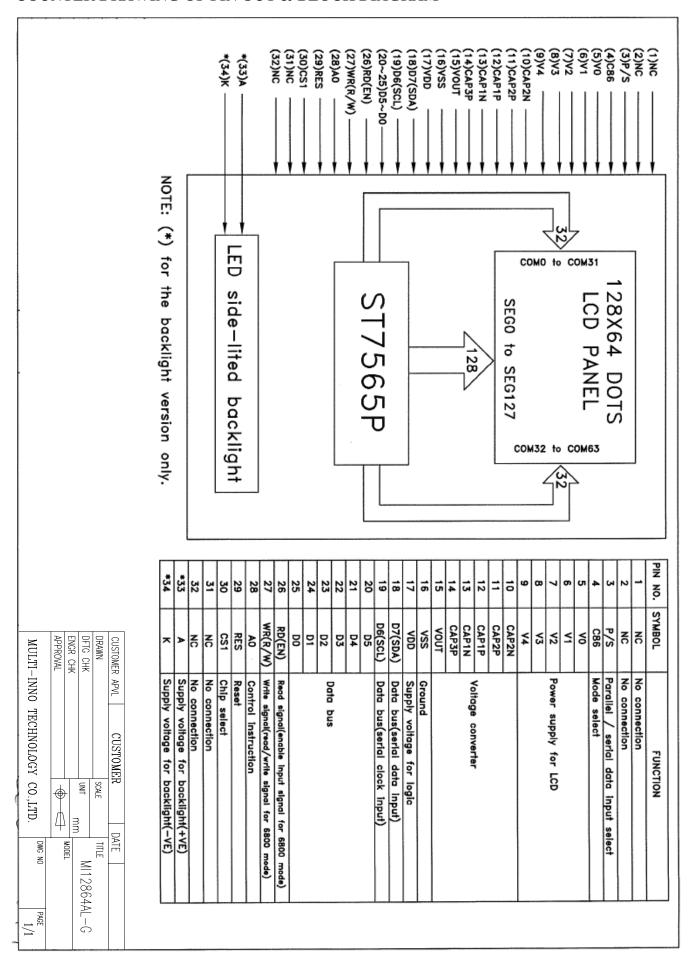


COUNTER DRAWING OF MODULE DIMENSION





COUNTER DRAWING OF PIN OUT & BLOCK DIAGRAM





ELECTRICAL CH	HARACTE	RIST	ICS				Co	nditions	: VSS	=0V, Ta=	25℃
Item	Symbol	MIN.	TYP.	MAX.	Unit	Item	Symbo	MIN.	TYP.	MAX.	Unit
							1				
Supply Voltage for Logic	Vdd	3.05	3.3	3.55	V	"H"Level Input Voltage	Vih	0.8VDD	_	VDD	V
Supply Current for Logic	Idd	_	0.23	0.34	mA	"L"Level Input Voltage	VIL	VSS	_	0.2VDD	V
Operating voltage for LCD	VLCD	8.8	9.0	9.2	V	_	_	_	_	_	_
Side-lited LED Backlig	ght Forward V	oltag	e (VF)	(*)		Side-lited LED Backlight Forward Current (IF)					
White(*)	VBL	3.05	3.3	3.55	V	White	IBL	_	40	60	mA
Blue(*)	VBL	3.05	3.3	3.55	V	Blue	IBL		40	60	mA

^(*)To meet the optimum brightness, the backlight should be driven by constant voltage 3.3V.

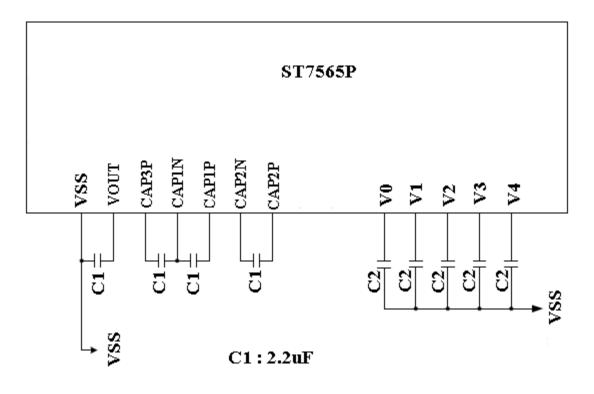
ABSOLUTE MAXIMUM RATINGS

Please make sure not to exceed the following maximum rating values under the worst application conditions

Item	Symbol	Rating (for normal temperature)	Rating (for wide temperature)	Unit
Supply Voltage	Vdd	-0.3 to +3.6	-0.3 to +3.6	V
Input Voltage	VT	-0.3 to VDD +0.3	-0.3 to V _{DD} +0.3	V
Operating Temperature	Topr	0 to 50	-20 to 70	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-10 to 60	-30 to 80	$^{\circ}\!\mathbb{C}$

REFERENCE CIRCUIT EXAMPLE

4x boosting circuit.



C2:2.2uF



INSTRUCTIONS TABLE

(Note) *: disabled data

Command				Cor	nma	ind (Code	9					Function
Command	A0	/RD	/WR	D7	D6	D5	D4	D3	D2	D	1	D0	T diretion
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1	Į.	0	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1	D	ispla	y st	art a	dd	re	ss	Sets the display RAM display start line address
(3) Page address set	0	1	0	1	0	1	1	Pa	ige a	add	lre	ess	Sets the display RAM page address
(4) Column address set upper bit Column address set lower bit	(Sec.)	1	0	0	0	0	0	colu	st s	ad	ldr	ess cant ress	Sets the most significant 4 bits of the display RAM column address. Sets the least significant 4 bits of the display RAM column address.
(5) Status read	0	0	1		St	atus		0	0	()	0	Reads the status data
(6) Display data write	1	1	0			,	Writ	e da	ta				Writes to the display RAM
(7) Display data read	1	0	1				Rea	d da	ta				Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	C)	0	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1		0	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	C)	0	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1	1	0	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565P)
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	()	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	1	0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	0	1	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0	*	*	k	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1		per		ing	Select internal power supply operating mode
(17) Vo voltage regulator internal resistor ratio set		1	0	0	0	1	0	0		esis atio		or	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume register set	0	1	0	1	0	0 Ele	0 ctro	0 nic v	0 olur			1 alue	Set the Vo output voltage electronic volume register
(20) Booster ratio set	0	1	0	1	1	1	1 0	1	0	st		0 o-up ue	select booster ratio 00: 2x,3x,4x 01: 5x 11: 6x
(21) Power saver													Display OFF and display all points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	1	1	1	Command for non-operation
(23) Test	0	1	0	1	1	1	1	*	*		*	*	Command for IC test. Do not use this command



RECOMMENDED INITIAL SETTINGS

Display Start Line Set: 40H

ADC Select : A0H LCD Bias Set : A2H

Common Output Mode Select : C0H

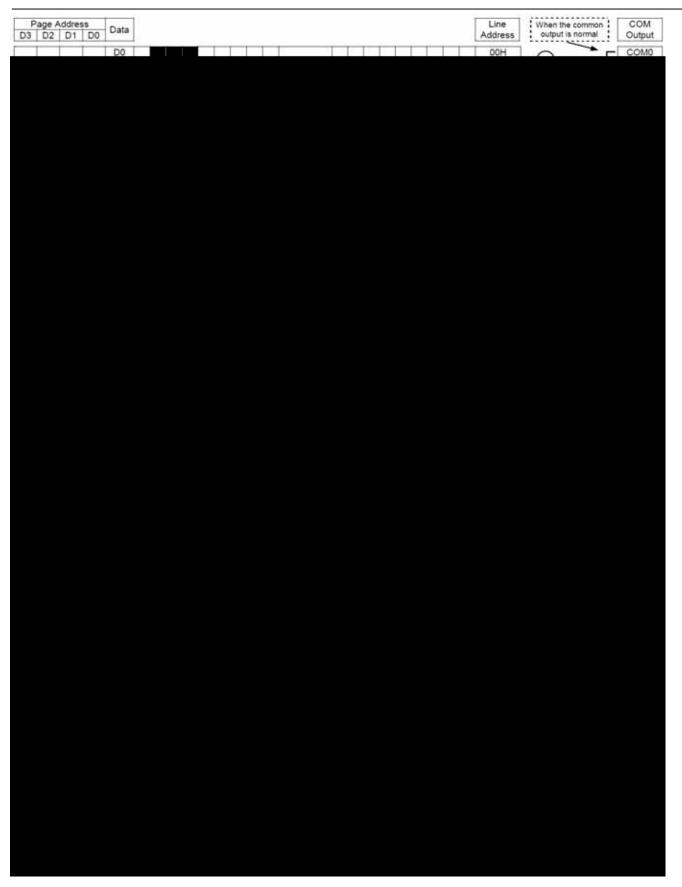
Power Control Set: 2FH

V0 Voltage Regulator Internal Resistor Ratio Set: 26H

Electronic Volume Register Set: 12H

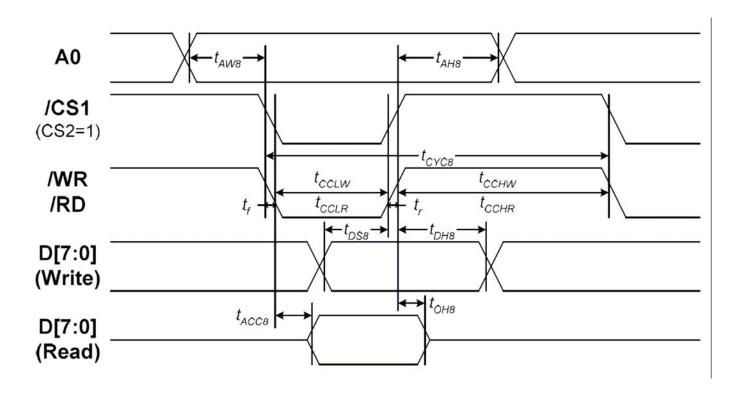
Booster Ratio Set: 00H





PARALLEL INTERFACE TIMING DIAGRAM (8080 MODE)



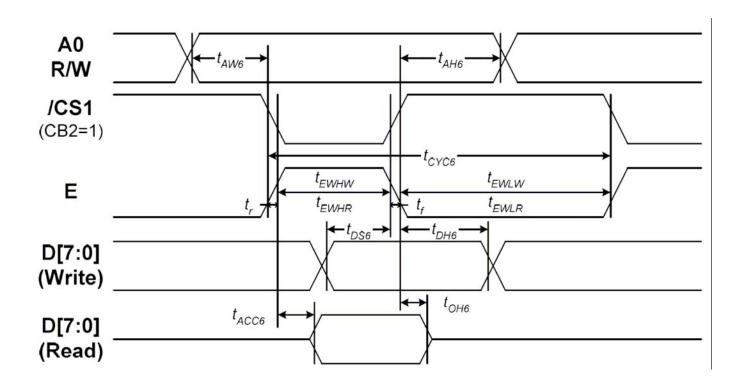


PARALLEL INTERFACE TIMING CHARACTERISTICS (8080 MODE)

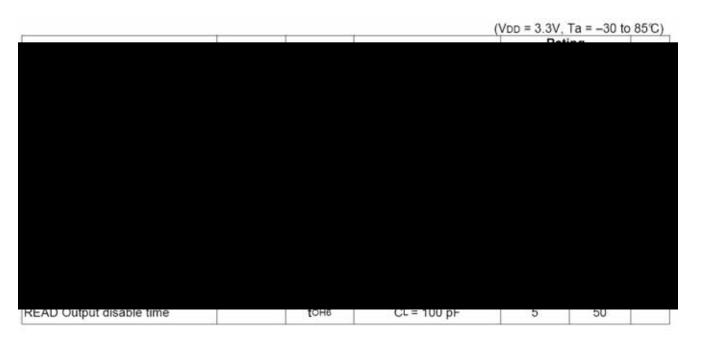
Item	Signal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min.	Max.	Units
Address hold time		tAH8		0	12.5	
Address setup time	A0	tAW8		0	-	
System cycle time		tcycs		240	77.2	
Write L pulse width	WR	tcclw		80		
Write H pulse width	/VV K	tcchw		80	_	
Read L pulse width	/RD	tcclr		140		Ns
Read H pulse width	/KD	tcchr		80		
Write Data setup time		tDS8		40	=	
Write Address hold time	D0 to D7	tDH8		0		
Read access time	D0 to D7	tACC8	CL = 100 pF	-	70	
Read Output disable time		tонв	CL = 100 pF	5	50	

PARALLEL INTERFACE TIMING DIAGRAM (6800 MODE)



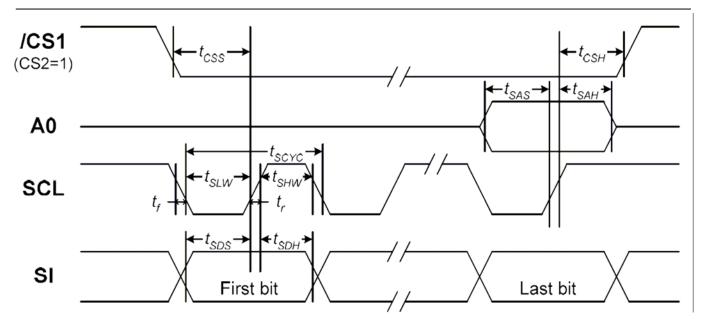


PARALLEL INTERFACE TIMING CHARACTERISTICS (6800 MODE)



SERIAL INTERFACE TIMING DIAGRAM



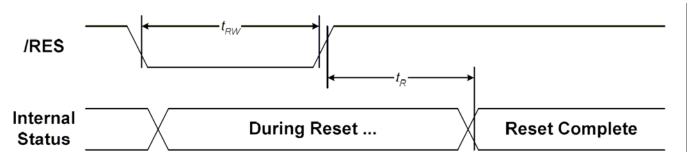


SERIAL INTERFACE TIMING CHARACTERISTICS

				3V, Ta = -30 t Rating	T
30000 DE 18000	AU				
Address hold time	AU	tsah	10	2-2	ns
Address hold time Data setup time	AU SI	t _{SAH}	10		ns



RESET TIMING DIAGRAM

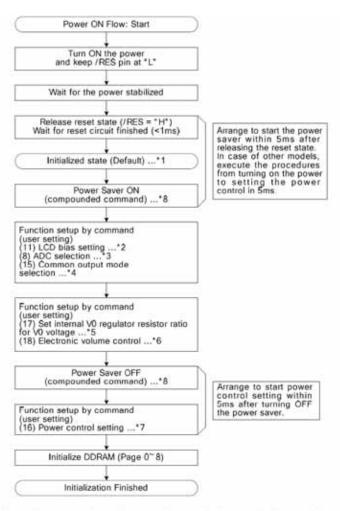


RESET TIMING

				(Vt	50 = 3.3V	1a = -30 t	10 85°C)
Item	Claust Combat C	Condition		Unite			
item	Signal	Symbol	Condition	Min.	Typ.	Max.	Units
Reset time	IDEC	t _R		1 12 -0 3	2-2	1.0	μs
Reset "L" pulse width	/RES	t _{RW}		1.0	1=1	_	μs



INITIALIZING WITHOUT THE BUILT-IN POWER SUPPLY CIRCUITS



^{*} The target time of 5ms will result to vary depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest you to conduct an operation check using the actual equipment.

Notes: Refer to respective sections or paragraphs listed below.

- *1: Description of functions; Resetting circuit
- *2: Command description; LCD bias setting
- *3: Command description; ADC selection
- *4: Command description; Common output state selection
- *5: Description of functions; Power circuit & Command description; Setting the built-in resistance radio for regulation of the V0 voltage
- *6: Description of functions; Power circuit & Command description; Electronic volume control
- *7: Description of functions; Power circuit & Command description; Power control setting
- *8: The power saver ON state can either be in sleep state or stand-by state. Command description; Power saver START (multiple commands)



MODULE NO.: MI12864AL-G Ver 1.0

ELECTRO-OPTICAL CHARACTERISTICS

MEASURING CONDITION: POWER SUPPLY = $V_{OP} / 64 \text{ Hz}$

TEMPERATURE = 23 ± 5 °C RELATIVE HUMIDITY = $60 \pm 20 \%$

ITEM	SYMBOL	UNIT	TYP. STN
RESPONSE TIME	Ton	ms	220
	Toff	ms	280
CONTRAST RATIO	Cr	-	12
	V3:00	0	40
VIEWING ANGLE	V6:00	0	70
(Cr ≥ 2)	V9:00	0	40
	V12:00	0	50

THE ELECTRO-OPTICAL CHARACTERISTICS ARE MEASURED VALUE BUT NOT GUARANTEED ONES.

RELIABILITY OF LCD MODULE

	TEST CONDITION	TEST CONDITION	
ITEM	FOR NORMAL TEMPERATURE	FOR WIDE TEMPERATURE	TIME
High temperature operating	50°C	70°C	240 hours
Low temperature operating	0°C	-20°C	240 hours
High temperature storage	60°C	80°C	240 hours
Low temperature storage	-10°C	-30°C	240 hours
Temperature-humidity storage	40°C 90% R.H.	60°C 90% R.H.	96 hours
Temperature cycling	-10°C to 60°C	-30°C to 80°C	5 ovele
	30 Min Dwell	30 Min Dwell	5 cycle
Vibration Test at LCM Level	Freq 10-55 Hz	Freq 10-55 Hz	
	Sweep rate: 10-55-10 at 1 min	Sweep rate: 10-55-10 at 1 min	
	Sweep mode Linear	Sweep mode Linear	_
	Displacement: 2 mm p-p	Displacement: 2 mm p-p	
	1 Hour each for X, Y, Z	1 Hour each for X, Y, Z	



QUALITY STANDARD OF LCD MODULE

1.0	Sampling Method				
	Sampling Plan: MIL STD 105 E				
	Class of AQL : Level II/Single Sampling				
	Critical: 0.25% Major 0.65% Minor 1.5%				
2.0	Defect Group	Failure Category	Failure Reasons		
	Critical Defect	Malfunction	Open		
	0.25%(AQL)		Short		
			Burnt or dead component		
			Missing part/improper part P.C.B.		
			Broken		
	Major Defect	Poor Insulation	Potential short		
	0.65%(AQL)		High current		
			Component damage or scratched		
			or Lying too close improper coating		
		Poor Conduction	Damage joint		
			Wrong polarity		
			Wrong spec. part		
			Uneven/intermittent contact		
			Loose part		
			Copper peeling		
			Rust or corrosion or dirt's		
	Minor Defect	Cosmetic Defect	Minor scratch		
	1.5%(AQL)		Flux residue		
			Thin solder		
			Poor plating		
			Poor marking		
			Crack solder		
			Poor bending		
			Poor packing		
			Wrong size		



SAMPLING METHOD

SAMPLING PLAN: MIL-STD 105E

CLASS OF AQL: LEVEL II/ SINGLE SAMPLING

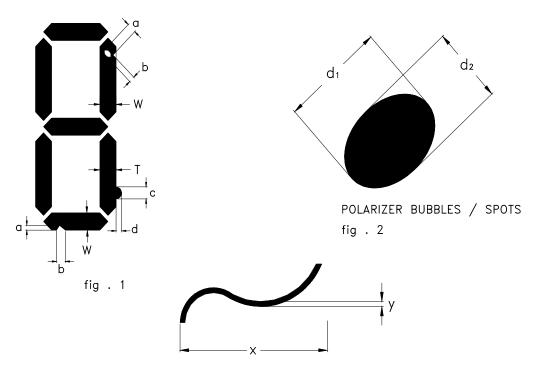
> MAJOR-0.65% MINOR - 1.5%

QUALITY STANDARD

DEFECT	CRITERIA		ТҮРЕ	FIGURE
SHORT CIRCUIT	-		MAJOR	-
MISSING SEGMENT	-		MAJOR	-
UNEVEN / POOR CONTRAST	-		MAJOR	-
CROSS TALK	-		MAJOR	-
PIN HOLE	$MAX(a,b) \leq 1/4 W$		MINOR	1
EXCESS SEGMENT	$MAX(c,d) \leq 1/4T$		MINOR	1
BUBBLES	d* ≥ 0.2	QTY=0	MINOR	2
BLACKS SPOTS	d ≤ 0.3	N.A.**	MINOR	2
	0.3 <d≤0.4< td=""><td>QTY≤1</td><td></td><td></td></d≤0.4<>	QTY≤1		
	0.4 <d< td=""><td>QTY=0</td><td></td><td></td></d<>	QTY=0		
LINE SCRATCHES	x≥0.7 y≥0.05	QTY=0	MINOR	3
BLACK LINE	x≥0.7 y≥0.05	QTY=0	MINOR	3

 $[*]d = MAX(d_1,d_2)$

DEFECT TABLE : B



LINE SCRATCHES / BLACK LINE fig . 3

^{**} N. A . = NOT APPLICABLE

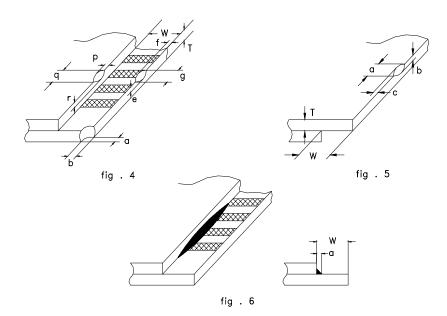


QUALITY STANDARD (CONT .)

DEFECT		CRITERIA	ТҮРЕ	FIGURE
	CONTACT EDGE	e≤1/2T f≤1/3W g≤3.5		4
CHIPS	BOTTOM GLASS	p≤1.0 q≤3.5 r≤1/2T	MINOR	4
	CORNER	a≤1.5 b≤W		4
	TOP GLASS	a≤3.0 b≤1/3T c≤1/2W		5
GLASS PROTRUSION		a ≤ 1/4 W	MINOR	6
RAINBOW	r	-	MINOR	-

UNLESS STATE OTHERWISE, ALL UNIT ARE IN MILLIMETER.







HANDLING PRECAUTIONS

(1) CAUTION OF LCD HANDLING & CLEANING

The polarizing plate on the surface of the panel is made from organic substances. Be very careful for chemicals not to touch the plate or it leads the polarizing plate to deteriorate.

If the use of a chemical is unavoidable, wipe the panel lightly with soft materials, such as gauze and absorbent cotton, soaked in a solvent.

- *Usable solvent: Alcohol (ethanol, IPA and the like)
- *Appropriate solvent: Ketones, ethyl alcohol

Avoid wiping with a dry cloth, since it could damage the surface of the polarizing plate and others.

(2) CAUTION AGAINST STATIC CHARGE

The LCD modules use CMOS LSI drivers, so customers are recommended that any unused input terminal would be connected to V_{DD} or V_{SS} , do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

(3) ESD PRECAUTION

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is recommended to take normal precautions appropriate to handling LCM module. For example: product surface grounding. Always take ESD precaution when handling the *LCD Module*. Components are exposed for direct finger touches and can be damaged unless ESD precaution is taken.

(4) PACKAGING

Avoid intense shock and falls from a height and do not operate or store them exposed to direct sunshine or high temperature/humidity for long periods.

(5) CAUTION FOR OPERATION

The viewing angle can be adjusted by varying the LCD driving voltage VO.

Driving voltage should be kept within specified range, excess voltage shortens display life.

Response time increases with decrease in temperature.

Display may turn black or dark Blue at temperature above its operational range; this is however not destructive and the display will return to normal once the temperature falls back to range.

Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured". They will recover once the display is turned off.

Condensation at terminals will cause malfunction and possible electrochemical reaction. Relative humidity of the environment should therefore be kept below 60%.

(6) SAFETY

Liquid crystal may leak out of a damaged LCD, it is recommended to wash off the liquid crystal by using solvents such as acetone or ethanol and should be burned up later.

If any liquid leak out of a damaged glass cell comes in contact with your hands, wash it off with soap and water immediately.

WARRANTY

Multi-Inno will replace or repair any of her LCD module in accordance with her LCD specification for a period of one year from date of shipment. The warranty liability of Multi-Inno is limited to repair and/or replacement. Multi-Inno will not be responsible for any subsequent or consequential event.